

### **Features**

- 3535 High Power LED
- ROHS and REACH Compliant
- MSL3 qualified according to J-STD 020
- ESD 2KV

## **Applications**

- Portable lighting
- Indoor/ Outdoor lighting
- Commercial lighting
- Industrial lighting

## **Description**

The IN-C33(X)TL(X) is a high-power LED. It is a SMD type LED which can be used in various applications.



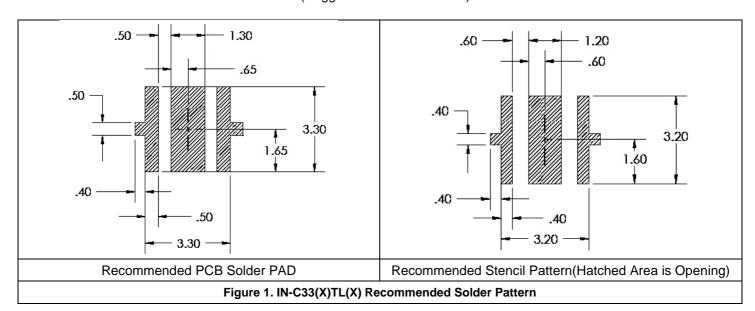




Outline						
60D	120D	90D				
3.5x3.5x2.8	3.5x3.5x2.0	3.5x3.5x2.34				
IN-C33BTL(X)	IN-C33CTL(X)	IN-C33ETL(X)				

### **Recommended Solder Pattern**

(Suggest Stencil t=0.12 mm)

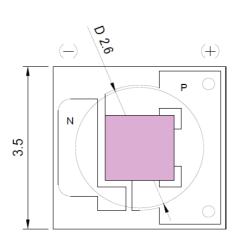


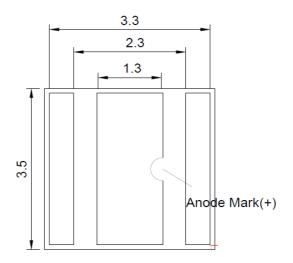
<sup>\*</sup>Note: All dimensions are in mm, tolerance is ±0.13mm

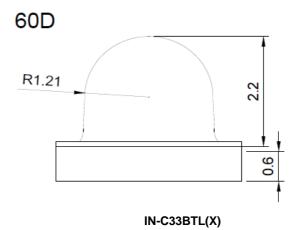


# **Package Dimensions**

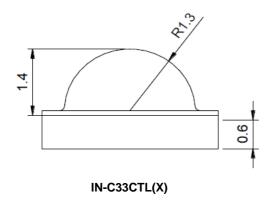
(All dimensions are in mm, tolerance is ±0.13mm)







120D



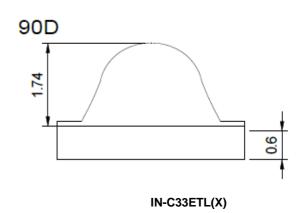


Figure 2. IN-C33(X)TL(X) Series Package Dimension



## **Absolute Maximum Rating(Ta=25°C)**

Characteristics	Symbol	Min.	Typical	Max.	Unit
DC Forward Current <sup>1</sup>	l <sub>F</sub>		350	700	mA
Pulse Forward Current <sup>2</sup>	I <sub>PF</sub>			1000	mA
Forward Voltage - Blue/Green/ Royal Blue	VF	2.8		3.8	V
Forward Voltage - Red/ Yellow/ Amber/ Deep Red	VF	1.4		2.8	V
Reverse Voltage	V <sub>R</sub>		-5		V
Leakage Current (5V)	I <sub>R</sub>			10	μA
Junction Temperature <sup>3</sup>	Tj		115		$^{\circ}\!\mathbb{C}$
Storage Temperature Range	T <sub>stg</sub>	-40	-	100	$^{\circ}\!\mathbb{C}$
Soldering Temperature	T <sub>sol</sub>		260		$^{\circ}\!\mathbb{C}$
Thermal Resistance Junction / Solder Point	R <sub>th</sub>	6	8	12	°C/W
Viewing Angle	2θ <sub>1/2</sub>		60/90/120		Deg

#### **Notes**

- 1. For other ambient, limited setting of current will depend on de-rating curves.
- 2. D=0.01s duty 1/10.
- 4. Viewing angle(2θ1/2) ±10°

#### **ESD Precaution**

ATTENTION: Electrostatic Discharge (ESD) protection

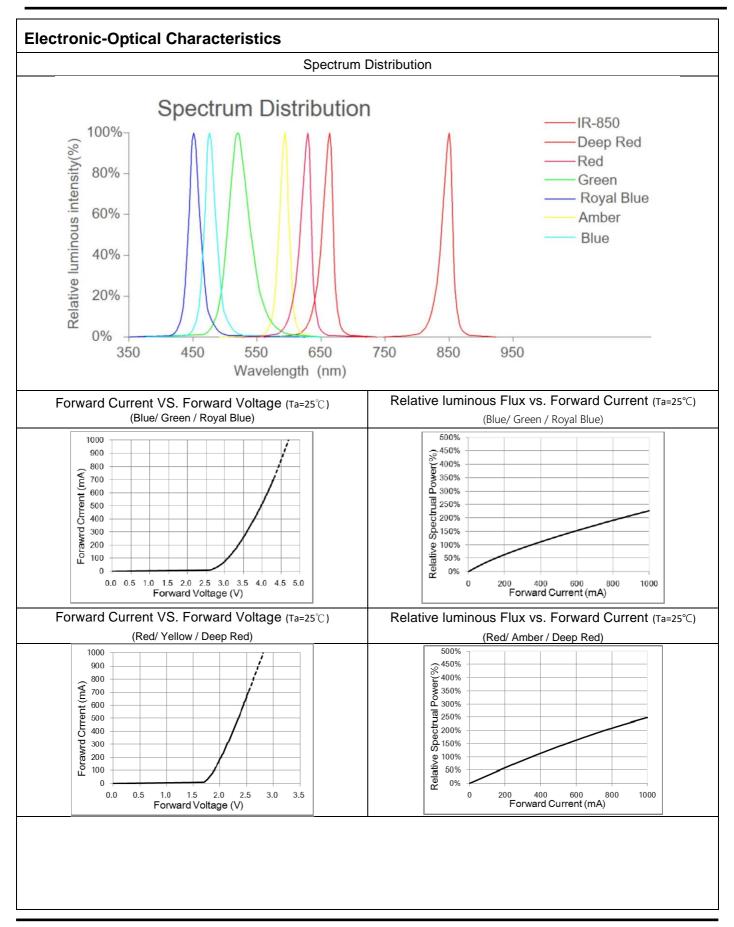


The symbol above denotes that ESD precaution is needed. ESD protection for GaP and AlGaAs based chips is necessary even though they are relatively safe in the presence of low static-electric discharge. Parts built with AllnGaP, GaN, or/and InGaN based chips are STATIC SENSITIVE devices. ESD precaution must be taken during design and assembly.

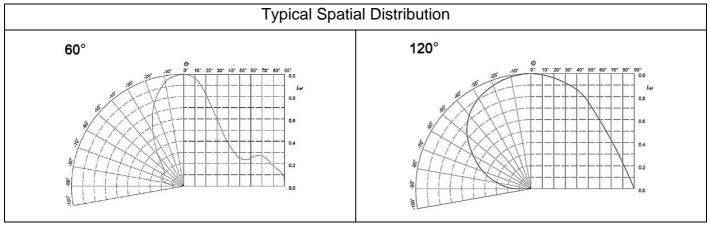
If manual work or processing is needed, please ensure the device is adequately protected from ESD during the process.

Please be advised that normal static precautions should be taken in the handling and assembly of this device to prevent damage or degradation which may be induced by electrostatic discharge (ESD).









## **Product List**

Part Number	Color	Luminous Flux (Im@350mA)		Wavelength (nm)	Forward Voltage (V)		
		Min	Max		Min	Max	
IN-C33(X)TLB	Blue	25	35	460-470	2.8	3.6	
IN-C33(X)TLG	Green	90	110	515-535	3.0	3.6	
IN-C33(X)TLR	Red	40	60	620-630	1.8	2.6	
IN-C33(X)TLY	Yellow	50	70	585-595	1.8	2.6	
IN-C33(X)TLDR	Deep Red	15	30	650-670	1.4	2.6	
IN-C33(X)TLRB	Royal Blue	15	30	450-460	2.8	3.6	
IN-C33(X)TLA	Amber	45	75	600-610	1.8	2.8	

## **Bin Code information**

## ■Forward Voltage Binning

Bin Code (@350mA)	Min. VF(V)	Max. VF(V)
V14	1.4	1.6
V16	1.6	1.8
V18	1.8	2.0
V20	2.0	2.2
V22	2.2	2.4
V24	2.4	2.6
V26	2.6	2.8
V28	2.8	3.0
V30	3.0	3.2
V32	3.2	3.4
V34	3.4	3.6
V36	3.6	3.8



# ■Flux Binning

Colon	Luminous I	lux (lm@3	50mA)
Color	Group	Min	Max
	B15	15	20
Blue	B20	20	25
	B25	25	30
	G80	80	90
Green	G90	90	100
	GH1	100	110
	R40	40	45
Dod	R45	45	50
Red	R50	50	55
	R55	55	60
	Y50	50	55
Vallani	Y55	55	60
Yellow	Y60	60	65
	Y65	65	70
	R15	15	20
Deep Red	R20	20	25
	R25	25	30
	B15	15	20
Royal Blue	B20	20	25
	B25	25	30
	A45	45	50
	A50	50	55
A make a se	A55	55	60
Amber	A60	60	65
	A65	65	70
	A70	70	75

#### Note:

1. Tolerance of luminous flux  $(\Phi v) \pm 5\%$ .



## ■Wavelength Binning

Calan	Wavelength	(Wd nm@	350mA)
Color	Group	Min	Max
Dlue	B1	460	465
Blue	B2	465	470
	G1	515	520
Croon	G2	520	525
Green	G3	525	530
	G4	530	535
Red	R1	620	625
Red	R2	625	630
Yellow	Y1	585	590
Yellow	Y2	590	595
Door Dod	DR1	650	660
Deep Red	DR2	660	670
Dovol Plus	RB1	450	455
Royal Blue	RB2	455	460
Ambar	A1	600	605
Amber	A2	605	610

#### Note:

- 1. Tolerance of Wavelength ±nm.
- 2. Wavelength of Deep Red is meaning peak wavelength only.

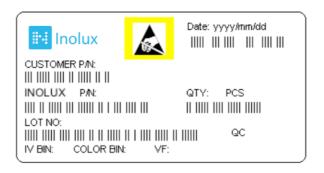


# **Ordering Information**

Orderable Part Number	Color			ous Flux 350mA)	Wavelength	Forward Voltage (V)		
Part Number			Min	Max	(nm)	Min	Max	
IN-C33BTLB		60	25	35	460-470	2.8	3.6	
IN-C33ETLB	Blue	90	25	35	460-470	2.8	3.6	
IN-C33CTLB		120	25	35	460-470	2.8	3.6	
IN-C33BTLG		60	90	110	515-535	3.0	3.6	
IN-C33ETLG	Green	90	90	110	515-535	3.0	3.6	
IN-C33CTLG		120	90	110	515-535	3.0	3.6	
IN-C33BTLR		60	40	60	620-630	1.8	2.6	
IN-C33ETLR	Red	90	40	60	620-630	1.8	2.6	
IN-C33CTLR		120	40	60	620-630	1.8	2.6	
IN-C33BTLY		60	50	70	585-595	1.8	2.6	
IN-C33ETLY	Yellow	90	50	70	585-595	1.8	2.6	
IN-C33CTLY		120	50	70	585-595	1.8	2.6	
IN-C33BTLDR		60	15	30	650-670	1.4	2.6	
IN-C33ETLDR	Deep Red	90	15	30	650-670	1.4	2.6	
IN-C33CTLDR		120	15	30	650-670	1.4	2.6	
IN-C33BTLRB		60	15	30	450-460	2.8	3.6	
IN-C33ETLRB	Royal Blue	90	15	30	450-460	2.8	3.6	
IN-C33CTLRB		120	15	30	450-460	2.8	3.6	
IN-C33BTLA		60	45	75	600-610	1.8	2.8	
IN-C33ETLA	Amber	90	45	75	600-610	1.8	2.8	
IN-C33CTLA		120	45	75	600-610	1.8	2.8	



# **Label Specifications**



## **Inolux P/N:**

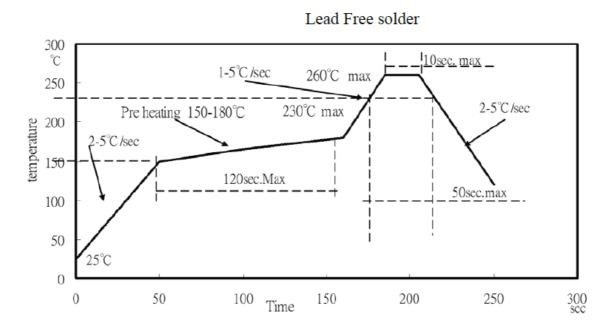
1	N	-	С	3	3	(X)	Т	L		(X)	-	X X X X
			Material	Pack	kage	Variation	Orientation	Current	Lens	Color		Customized Stamp-off
Ino SN	-		C = Ceramic Type	33C =	3.5 x 3	.5, 60 Deg. 5, 120 Deg. .5, 90 Deg.	T = Top Mount	L = 350mA	(Blank) = Clear	B = 470nm G = 520nm R = 630nm Y = 590nm DR = 660nm RB = 450nm A = 605nm		

#### Lot No.:

Z	2	0	1	7	01	24	001
Internal Tracker		Year (2017	, 2018,)		Month	Date	Serial



# **Reflow Soldering**



# **Soldering Iron**

Basic Spec is  $\leq$  4 sec. when 260°C (+10°C  $\rightarrow$  -1 second). Power dissipation of Iron should be less than 15W. Surface temperature should be under 230°C

### Rework

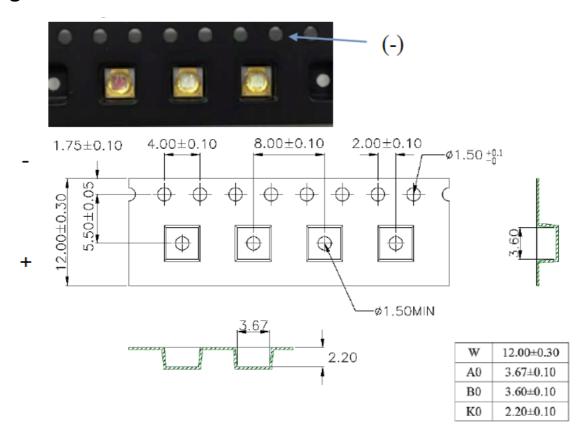
Rework should be completed within 4 second under 245°C

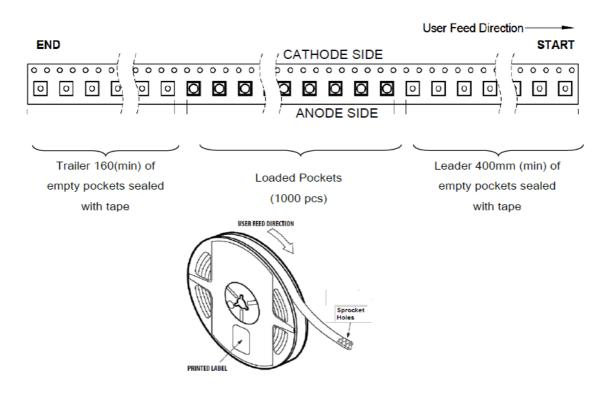
### **Notes**

- 1. Do not stress the silicone resin while it is exposed to high temperature.
- 2. The number of reflow process should not exceed 3 times.

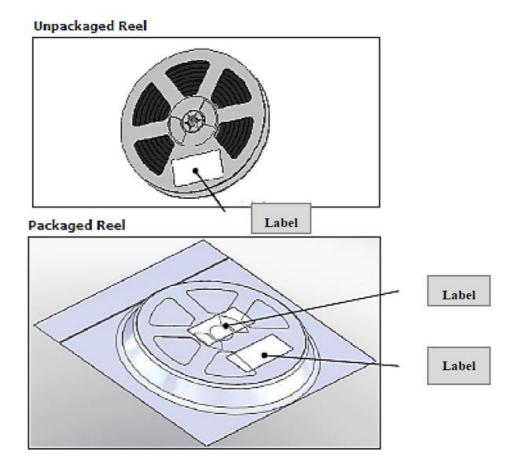


# **Packing**









#### Notes:

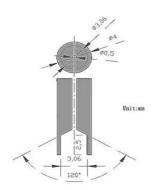
- 1. Each Reel (minimum number of pieces is 100 and maximum is 500 (60D)/1000 (120D) is packed in a moisture-proof bag along with 2 packs of desiccant and a humidity indicator card;
- 2. A maximum of 5 moisture-proof bags are packed in an inner box (size: 240mm x 200mm x 105mm ±5mm)
- 3. A maximum of 4 inner boxes are put in an outer box (size: 410mm x 255mm x 230mm  $\pm$ 5mm)
- 4. Part No., Lot No., quantity should be indicated on the label of the moisture-proof bag and the cardboard box.



### **Precautions**

- 1. Recommendation for using LEDs
  - 1.1 The lens of LEDs should not be exposed to dust or debris. Excessive dust and debris may cause a drastic decrease in the luminosity.
  - 1.2 Avoid mechanical stress on LED lens.
  - 1.3 Do not touch the LED lens surface. It would affect the optical performance of the LED due to the LED lens' damage.
  - 1.4 Pick & place tools are recommended for the remove of LEDs from the factory tape & reel packaging
- 2. Pick & place nozzle

The pickup tool was recommended and shown as below



### 3. Lens handling

Please follow the guideline to pick LEDs

- 3.1 Use tweezers to pick LEDs
- 3.2 Do not touch the lens by using tweezers
- 3.3 Do not touch lens with fingers
- 3.4 Do not apply more than 4N of lens (400g) directly onto the lens

#### 4. Lens cleaning

In the case which a small amount of dirt and dust particles remain on the lens surface, a suitable cleaning solution can be applied.

- 4.1 Try a gentle wiping with dust-free cloth
- 4.2 If needed, use dust-free cloth and isopropyl alcohol to gently clean the dirt from the lens surface.
- 4.3 Do not use other solvents as they may directly react with the LED assembly
- 4.4 Do not use ultrasonic cleaning which will damage the LEDs



# **Test Items and Results of Reliability**

Test Item	Test Conditions	Duration/ Cycle	Number of Damage	Reference
Thermal Shock	-40°C 30min ↑↓5min 125°C 30min	100 cycles	0/22	AECQ101
High Temperature Storage	Ta=100°ℂ	1000 hrs	0/22	EIAJ ED-4701 200 201
Humidity Heat Storage	Ta=85°C RH=85%	1000 hrs	0/22	EIAJ ED-4701 100 103
Low Temperature Storage	Ta=-40°C	1000 hrs	0/22	EIAJ ED-4701 200 202
Life Test	Ta=25°ℂ If=350mA	1000 hrs	0/22	Tested with Inolux standard
High Humidity Heat Life Test	85°C RH=85% If=350mA	1000 hrs	0/22	Tested with Inolux standard
High Temperature Life Test	Ta=85℃	1000 hrs	0/22	Tested with Inolux standard
ESD(HBM)	2KV at 1.5kΩ;100pf	3 Times	0/22	MIL-STD-883

Criteria for Judging the Damage							
11	Ch.a.l	Caradinia	Criteria for Judgment				
Item	Symbol	Condition	Min	Max			
Forward Voltage	$V_{F}$	If=350mA	-	USL <sup>1</sup> ×1.1			
Reverse Current	I <sub>R</sub>	VR =5V	-	100μΑ			
Luminous Intensity	I <sub>v</sub>	If=350mA	LSL <sup>2</sup> ×0.7	-			

#### Notes:

1. USL: Upper specification level

2. LSL: Lower specification level



**Revision History** 

Changes since last revision	Page	Version No.	Revision Date
Initial Release		1.0	04-17-2018
Revise Format		1.1	10-18-2018
Revise the Drawing	4	1.2	06-19-2021

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